

XI'AN IR-PERI



Company

PRELIMINARY

Fast Recovery Epitaxial Diode INT-A -PAK

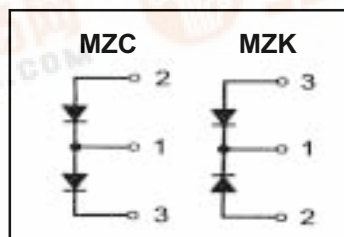
MZC400TS60U

MZK400TS60U

Ultra-Fast™ Speed FRED

Features

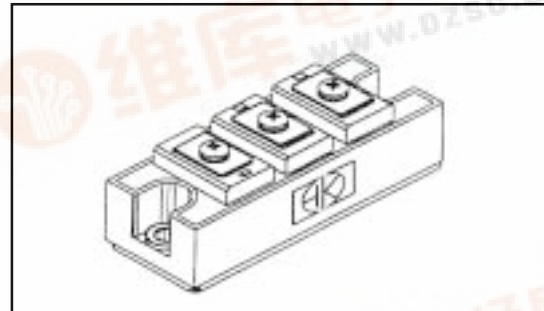
- International standard package
With DBC ceramic base plate
- Planar passivated chips
- Short recovery time
- Low switching losses
- Ultra-soft recovery behaviour
- Industry standard package
- UL recognition pending



$V_{RRM} = 600V$
 $I_{FAVM} = 400A$
 $t_{rr} = 250ns$

Benefits

- Antiparallel diode for high frequency switching devices
- Increased operating efficiency
- Direct mounting to heatsink
- Uninterruptible power supplies (UPS)
- Ultrasonic cleaners and welders
- Low voltage peaks for reduced protection circuits



Absolute Maximum Ratings

Symbol	Test Conditions	Max.	Units
V_{RSM} & V_{RRM}		600	V
I_{FRMS}	$T_C = 75^\circ C$	560	A
I_{FAVM}	$T_C = 75^\circ C$; rectangular, $d = 0.5$	400	A
I_{FRM}	$t_p < 10\mu s$; rep. rating, pulse width limited by T_{VJM}	2185	A
I_{FSM}	$T_{VJ} = 45^\circ C$; $t = 10ms$ (50 Hz), sine	3300	A
	$t = 8.3ms$ (60 Hz), sine	3600	A
	$T_{VJ} = 150^\circ C$; $t = 10ms$ (50 Hz), sine	2880	A
	$t = 8.3ms$ (60 Hz), sine	3180	A
I^2t	$T_{VJ} = 45^\circ C$; $t = 10ms$ (50 Hz), sine	38400	A^2s
	$t = 8.3ms$ (60 Hz), sine	39100	A^2s
	$T_{VJ} = 150^\circ C$; $t = 10ms$ (50 Hz), sine	31100	A^2s
	$t = 8.3ms$ (60 Hz), sine	31800	A^2s
V_{ISOL}	RMS Isolation Voltage, Any Terminal To Case, $t = 1 min$	2500	V
P_D	$T_C = 25^\circ C$	1008	W
T_J	Operating Junction Temperature Range	-40 to +150	$^\circ C$
T_{STG}	Storage Temperature Range	-40 to +125	

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Thermal / Mechanical Characteristics

	Parameter	Typ.	Max.	Units
R _{θJS}	Thermal Resistance, Junction-to- Sink DC	-	0.202	
R _{θJC}	Thermal Resistance, Junction-to- Case DC	-	0.122	°C/W
R _{θCS}	Thermal Resistance, Case-to- Sink- Module	0.08	-	
	Mouting Torque, Case-to-Heatsink	-	4.0	N.m
	Mouting Torque, Case-to-Terminal 1,2 & 3	-	3.0	
	Weight of Module	200	-	g

Electrical Characteristics (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
V _{RRM}	Reverse Breakdown Voltage	600	-	-	V	I _R =16mA
I _R	Diode Leaking Current	-	-	16	mA	T _{VJ} =25 °C V _R =V _{RRM}
		-	-	5	mA	T _{VJ} =25 °C V _R =0.8V _{RRM}
		-	-	100	mA	T _{VJ} =125 °C V _R =0.8V _{RRM}
V _F	Diode Forward Voltage	-	-	1.17	V	I _F =230A; T _{VJ} =125 °C
		-	-	1.36	V	T _{VJ} = 25 °C
		-	-	1.41	V	I _F =400A; T _{VJ} =125 °C
		-	-	1.52	V	T _{VJ} = 25 °C
V _{TO}	For power-loss calculations only	-	-	0.85	V	
r _T		-	-	1.14	mΩ	
trr@T _{VJ} =100 °C	Diode Reverse Recovery Time	-	250	300	ns	I _F =400A
I _{RM} @T _{VJ} = 25 °C	Diode Peak Reverse Current	-	-	66	A	V _R =300V
I _{RM} @T _{VJ} =100 °C	Diode Peak Reverse Current	-	-	110	A	-di/dt=600A/μs

Case Outline - Int-a-bak

